

2A, 200V - 1000V Fast Recovery Surface Mount Rectifier

FEATURES

- AEC-Q101 qualified
- Glass passivated chip junction
- Ideal for automated placement
- Low power loss, high efficiency
- Fast switching for high efficiency
- Low profile package
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

KEY PARAMETERS

PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	200 - 1000	V
I_{FSM}	50	A
$T_{J\ MAX}$	175	°C
Package	Thin SMA	
Configuration	Single die	

APPLICATIONS

- Freewheeling
- Snubber
- DC/DC converters
- Automotive application



Thin SMA



MECHANICAL DATA

- Case: Thin SMA
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.029g (approximately)

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	SYMBOL	RS2D ALH	RS2G ALH	RS2J ALH	RS2K ALH	RS2M ALH	UNIT	
Marking code on the device		RS2DAH	RS2GAH	RS2JAH	RS2KAH	RS2MAH		
Repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	V	
Reverse voltage, total rms value	$V_{R(RMS)}$	140	280	420	560	700	V	
Forward current	I_F	2					A	
Surge peak forward current, single half sine-wave superimposed on rated load	$t = 8.3\text{ms}$	I_{FSM}					50	A
	$t = 1.0\text{ms}$						140	A
Junction temperature	T_J	-55 to +175					°C	
Storage temperature	T_{STG}	-55 to +175					°C	

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	16	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	73	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	14	°C/W

Thermal Performance Note: Units mounted on PCB (5mm x 5mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	RS2DALH RS2GALH RS2JALH	$I_F = 1\text{A}, T_J = 25^\circ\text{C}$	V_F	0.93	-	V
		$I_F = 2\text{A}, T_J = 25^\circ\text{C}$		1.01	1.30	V
		$I_F = 1\text{A}, T_J = 125^\circ\text{C}$		0.78	-	V
		$I_F = 2\text{A}, T_J = 125^\circ\text{C}$		0.88	1.02	V
	RS2KALH RS2MALH	$I_F = 1\text{A}, T_J = 25^\circ\text{C}$		0.98	-	V
		$I_F = 2\text{A}, T_J = 25^\circ\text{C}$		1.06	1.30	V
		$I_F = 1\text{A}, T_J = 125^\circ\text{C}$		0.83	-	V
		$I_F = 2\text{A}, T_J = 125^\circ\text{C}$		0.93	1.05	V
Reverse current @ rated V_R ⁽²⁾		$T_J = 25^\circ\text{C}$	I_R	-	1	μA
		$T_J = 125^\circ\text{C}$		-	40	μA
Reverse recovery time	RS2DALH RS2GALH	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	t_{rr}	-	150	ns
	RS2JALH			-	250	ns
	RS2KALH RS2MALH			-	500	ns
Junction capacitance	RS2DALH RS2GALH RS2JALH	1MHz, $V_R = 4.0\text{V}$	C_J	11	-	pF
	RS2KALH RS2MALH			10	-	pF

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
RS2xALH	Thin SMA	14,000 / Tape & Reel

Notes:

1. "x" defines voltage from 200V(RS2DALH) to 1000V(RS2MALH)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

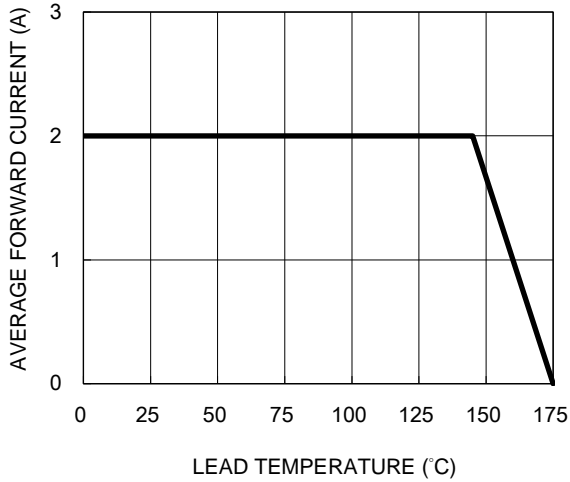


Fig.2 Typical Junction Capacitance

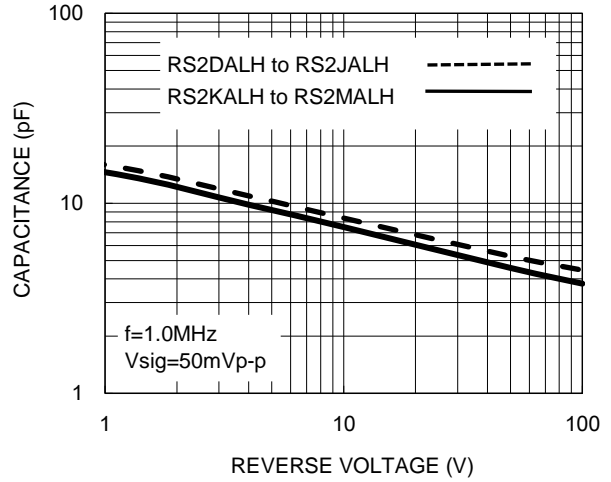


Fig.3 Typical Reverse Characteristics

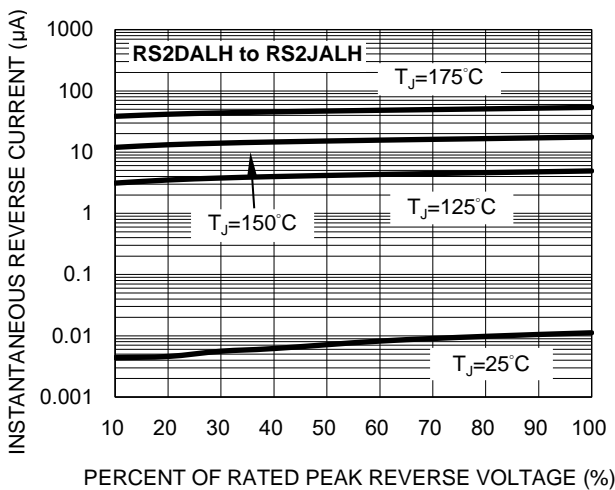


Fig.4 Typical Forward Characteristics

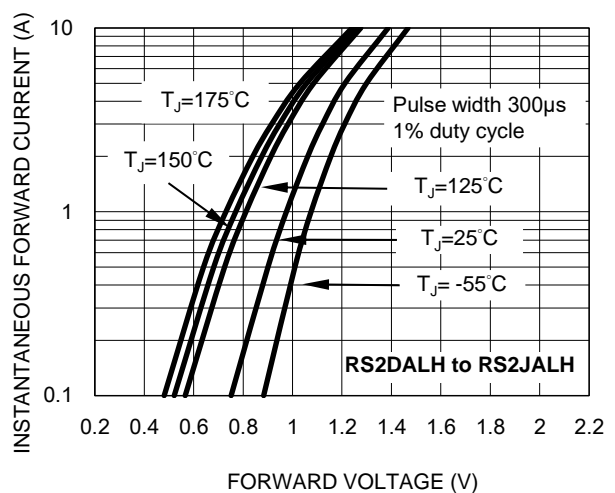


Fig.5 Typical Reverse Characteristics

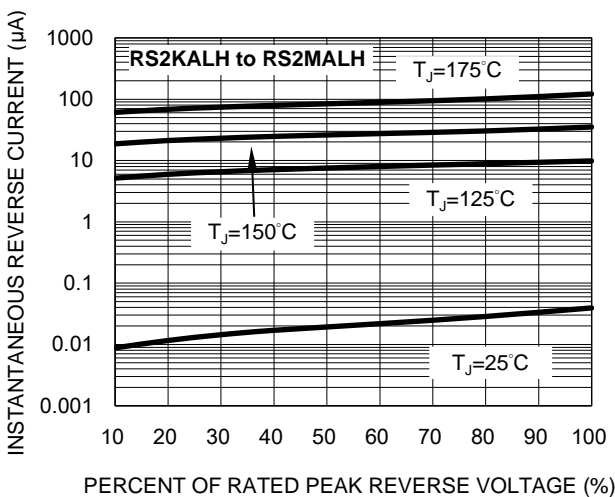
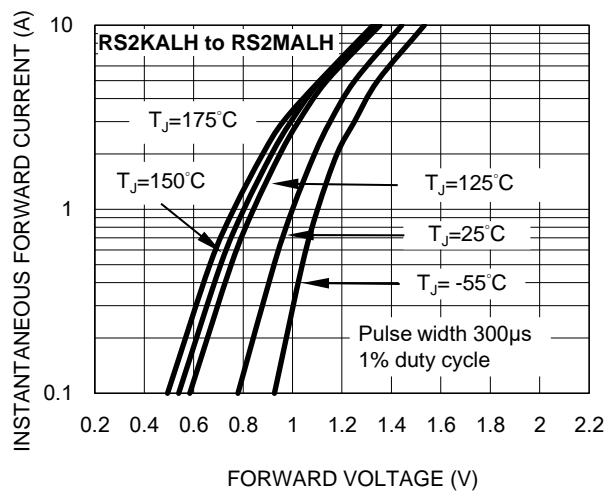


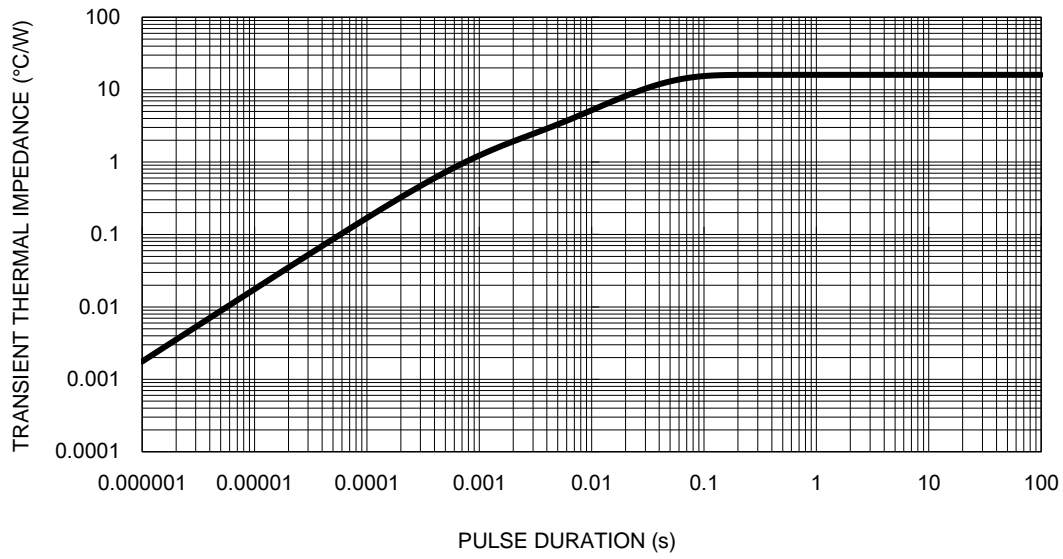
Fig.6 Typical Forward Characteristics



CHARACTERISTICS CURVES

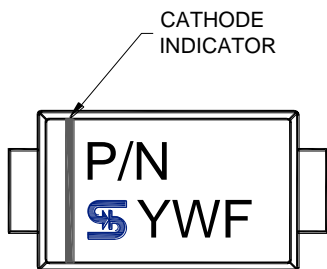
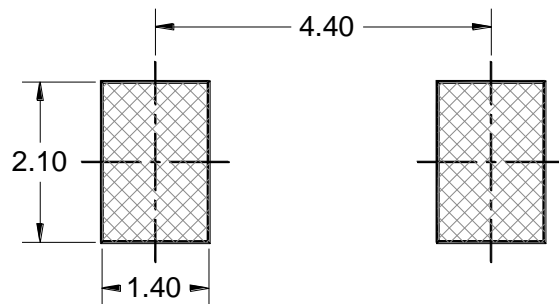
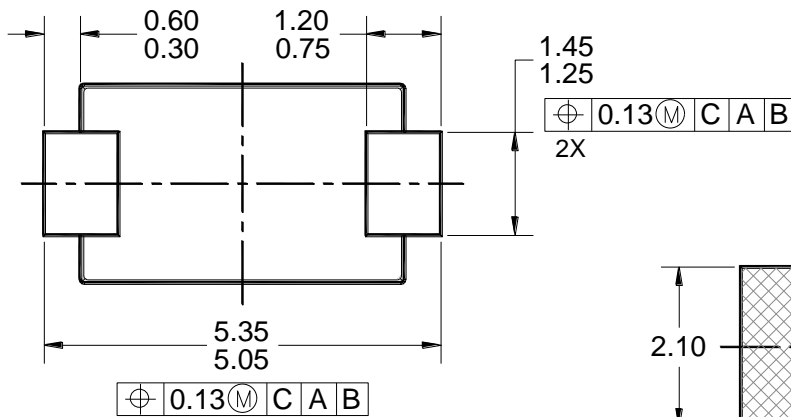
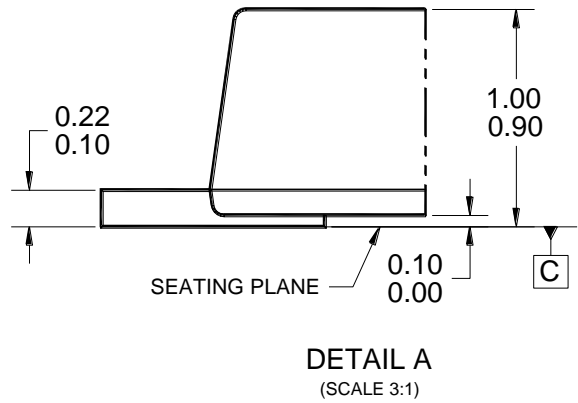
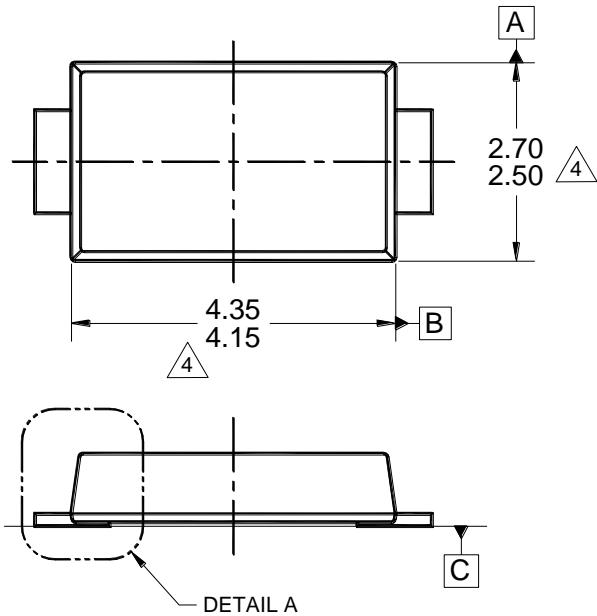
(T_A = 25°C unless otherwise noted)

Fig.7 Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS

Thin SMA



MARKING DIAGRAM

P/N = MARKING CODE
YW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-2009.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-221, VARIATION AC, ISSUE B.
4. $\triangle 4$ MODDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. SUGGESTED PAD LAYOUT IS FOR REFERENCE PURPOSE ONLY.
6. DWG NO. REF: HQ2SD07-TSMA-074 REV A.

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